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DZQA6V8AXV5

QUAD SURFACE MOUNT TVS ARRAY

Features

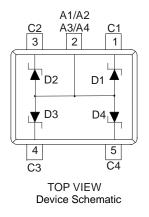
- Quad TVS in Common Anode Configuration
- Ultra-Small Surface Mount Package
- Ideal For Transient Suppression and ESD Protection
- Lead Free By Design/RoHS Compliant (Note 1)
- "Green Device" (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

ESD Capability

- IEC 61000-4-2 Contact Method ±8kV
- IEC 61000-4-2 Air Discharge Method ±15kV

Mechanical Data

- Case: SOT553
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish: Matte Tin, Annealed Over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.002 grams (approximate)



Ordering Information (Note 3)

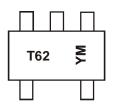
| Part Number | Case | Packaging |
|---------------|--------|------------------|
| DZQA6V8AXV5-7 | SOT553 | 3000/Tape & Reel |

1. No purposefully added lead.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



T62 = Product type marking code YM = Date code marking Y = Year (Ex: W = 2009) M = Month (ex: 9 = September)

Date Code Key

Notes:

| Year | 2009 | 9 | 2010 | | 2011 | | 12 | 2013 | | 2014 | | 2015 |
|-------|------|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Code | W | | Х | | Y | | Z | | | В | | С |
| Month | Jan | Feb | Mar | Apr | Мау | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



Maximum Ratings @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|---|--------|-------|------|
| Forward Voltage @ I _F = 10mA | VF | 0.9 | V |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Notes 4 & 5) | PD | 380 | mW |
| Peak Power Dissipation, 8x20µS Waveform (Note 6) | P _{pk} | 20 | W |
| Thermal Resistance, Junction-to-Ambient (Note 4) | $R_{	ext{	heta}JA}$ | 327 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | ٥C |

Electrical Characteristics @T_A = 25°C unless otherwise specified

| Туре | Marking | 0 | | Leakage Current (Note 7) | | Clamping Voltage (Note 6) | | Capacitance @0V Bias(pF) (Note 8) | | Capacitance @3V Bias(pF) (Note 8) | | |
|-------------|---------|--|---------|-----------------------------------|---------|--------------------------------------|--------------------|---|------|---|-----|-----|
| Number | Code | V _{BR} @ I _T = 1mA | | I _{RM} @ V _{RM} | | V _C Max @ I _{PP} | | CT | | Ст | | |
| | | Min (V) | Nom (V) | Max (V) | Max(µA) | (V) | V _c (V) | IPP(A) | Тур | Max | Тур | Max |
| DZQA6V8AXV5 | T62 | 6.47 | 6.8 | 7.14 | 1 | 4.3 | 13 | 1.6 | 12.5 | 15 | 7.6 | 9.5 |

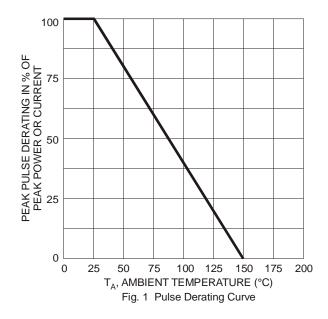
Notes: 4. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. Suggested Pad Layout Document AP02001,

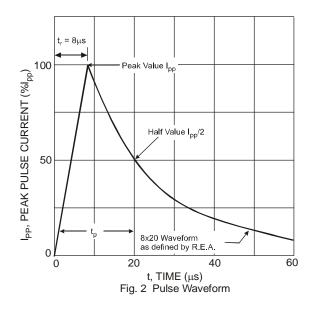
which can be found on our website at http://www.diodes.com.

5. Only 1 diode under power. For all 4 diodes under power, P_D will be 25% of the listed value. 6. Non-repetitive current pulse per Figure 3 and derate above $T_A = 25^{\circ}$ C per Figure 1.

7. Short duration pulse test used to minimize self-heating effect.

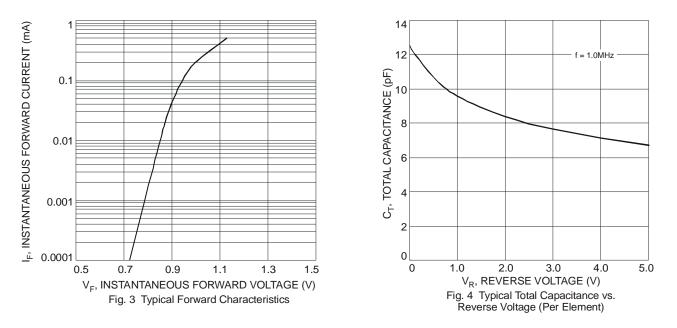
8. Per element, f = 1MHz, $T_A = 25^{\circ}C$



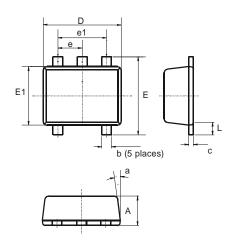




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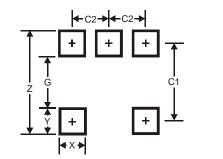


Package Outline Dimensions



| SOT553 | | | | | | | |
|--------|----------------|--------------|------|--|--|--|--|
| Dim | Min Max Typ | | | | | | |
| Α | 0.55 | 0.60 | 0.60 | | | | |
| C | 0.10 | 0.10 0.18 0. | | | | | |
| D | 1.50 1.70 1.60 | | | | | | |
| Е | 1.55 | 1.70 | 1.60 | | | | |
| E1 | 1.10 | 1.25 | 1.20 | | | | |
| L | 0.10 | 0.30 | 0.20 | | | | |
| b | 0.15 0.30 0.2 | | 0.20 | | | | |
| е | 0.50 Typ | | | | | | |
| e1 | 1 | .00 Тур | | | | | |
| а | 6° 8° | | 7° | | | | |
| All | Dimens | ions in I | mm | | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.2 |
| G | 1.2 |
| Х | 0.375 |
| Y | 0.5 |
| C1 | 1.7 |
| C2 | 0.5 |



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